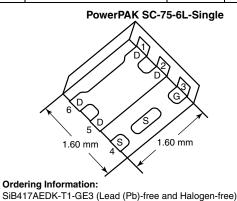




P-Channel 1.2 V (G-S) MOSFET

PRODUCT SUMMARY									
V _{DS} (V)	$R_{DS(on)}(\Omega)$ Max.	I _D (A) ^g	Q _g (Typ.)						
	0.032 at $V_{GS} = -4.5 \text{ V}$	- 9 ^a							
- 8	0.045 at $V_{GS} = -2.5 \text{ V}$	- 9 ^a							
	0.063 at V _{GS} = - 1.8 V	- 9 ^a	11.3 nC						
	0.120 at V _{GS} = - 1.5 V	- 8.8							
	0.230 at V _{GS} = - 1.2 V	- 6.4							



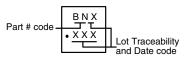
FEATURES

- TrenchFET® Power MOSFET
- Thermally Enhanced PowerPAK® SC-75 Package
 - Small Footprint Area
 - Low On-Resistance
- 100 % R_g Tested
- Typical ESD Protection 2500 V
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Load Switch for Portable Devices, Smart Phones, and Tablet PC
 - Low Voltage Drop
 - Space Savings

Marking Code





HALOGEN FREE

o s

S	G
,	P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$S (T_A = 25 °C, unleady$	ess otherwise r	noted)			
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage		V_{DS}	- 8	V		
Gate-Source Voltage		V_{GS}	± 5	v		
Continuous Drain Current (T _J = 150 °C)	$T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 70 ^{\circ}\text{C}$ $T_{A} = 25 ^{\circ}\text{C}$ $T_{A} = 70 ^{\circ}\text{C}$	I _D	- 9 ^a - 9 ^a - 7.2 ^{b, c} - 5.7 ^{b, c}	A		
Pulsed Drain Current (t = 300 μs)		I _{DM}	- 15			
Continuous Source-Drain Diode Current	$T_C = 25 ^{\circ}C$ $T_A = 25 ^{\circ}C$	I _S	- 9 ^a - 2 ^{b, c}			
Maximum Power Dissipation	$T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 70 ^{\circ}\text{C}$ $T_{A} = 25 ^{\circ}\text{C}$ $T_{A} = 70 ^{\circ}\text{C}$. P _D	13 8.4 2.4 ^{b, c} 1.6 ^{b, c}	W		
Operating Junction and Storage Temperature Ra	ange	T _J , T _{stg}	- 55 to 150	°C		
Soldering Recommendations (Peak Temperature	e) ^{d, e}		260	30		

THERMAL RESISTANCE RATINGS									
Parameter		Symbol	Typical	Maximum	Unit				
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	t ≤ 5 s R _{thJA} 41 51		°C/W					
Maximum Junction-to-Case (Drain)	Steady State R _{thJC} 7.5 9.5			O/ VV					

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SC-75 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 105 °C/W.
- g. Based on $T_C = 25$ °C.

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SPECIFICATIONS (T _J = 25 °C			N/2	T	Mess	11 !4			
Parameter Static	Symbol	Test Conditions	Min.	Тур.	Max.	Unit			
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 8			V			
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	- GS = 0 +, D = 200 m t	- 0	- 6.1		mV/°C			
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		2.1					
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.35	2.1	- 1	V			
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 5 \text{ V}$	0.00		± 20	•			
Gaio Course Lourings	-033	$V_{DS} = -8 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	μΑ			
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -8 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			- 10				
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 15			Α			
	,	V _{GS} = - 4.5 V, I _D = - 3 A		0.0265	0.0320				
		V _{GS} = - 2.5 V, I _D = - 3 A		0.0360	0.0450				
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 1.8 V, I _D = - 1 A		0.0500	0.0630	Ω			
	= = (:)	V _{GS} = - 1.5 V, I _D = - 0.5 A		0.0600	0.1200	00			
		V _{GS} = - 1.2 V, I _D = - 0.5 A		0.1000	0.2300				
Forward Transconductance ^a	g _{fs}	V _{DS} = - 4 V, I _D = - 7.4 A		18		S			
Dynamic ^b				l					
Input Capacitance	C _{iss}			878		pF			
Output Capacitance	C _{oss}	$V_{DS} = -4 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		415					
Reverse Transfer Capacitance	C _{rss}			735					
Total Cata Chargo	Q_g	$V_{DS} = -4 \text{ V}, V_{GS} = -5 \text{ V}, I_{D} = -7.4 \text{ A}$		12.3	18.5	nC			
Total Gate Charge				11.3	17				
Gate-Source Charge	Q_{gs}	$V_{DS} = -4 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -7.4 \text{ A}$		1.35					
Gate-Drain Charge	Q_gd			3.42					
Gate Resistance	R_g	f = 1 MHz	1.3	6.5	13	Ω			
Turn-On Delay Time	t _{d(on)}			19	29				
Rise Time	t _r	V_{DD} = - 4 V, R_L = 0.68 Ω		18	27	- ns			
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 5.9 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		32	48				
Fall Time	t _f			19	29				
Drain-Source Body Diode Characterist	ics								
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 9	Α			
Pulse Diode Forward Current	I _{SM}				- 15				
Body Diode Voltage	V_{SD}	$I_S = -5.9 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.8	- 1.2	V			
Body Diode Reverse Recovery Time	t _{rr}			32	48	ns			
Body Diode Reverse Recovery Charge	Q_{rr}	I _F = - 5.9 A, dI/dt = 100 A/μs, T _J = 25 °C		13	20	nC			
Reverse Recovery Fall Time	t _a			14		ns			
Reverse Recovery Rise Time	t _b			18		110			

Notes:

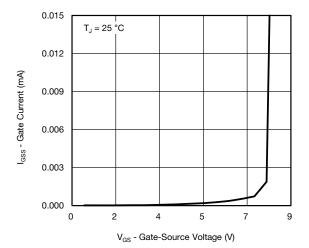
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

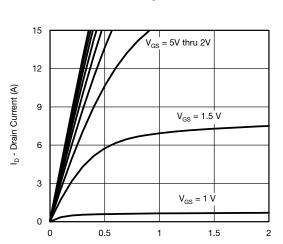
b. Guaranteed by design, not subject to production testing.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

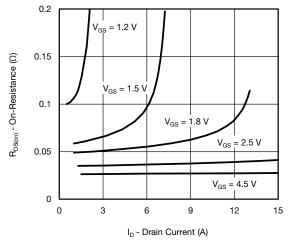


Gate Source Voltage vs. Gate Current

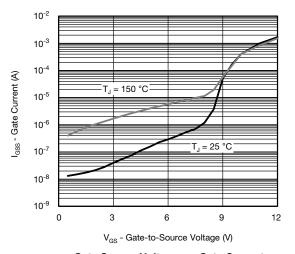


V_{DS} - Drain-to-Source Voltage (V)

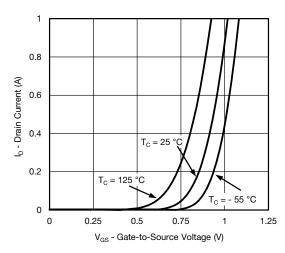
Output Characteristics



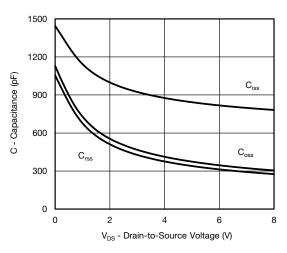
On-Resistance vs. Drain Current and Gate Voltage



Gate Source Voltage vs. Gate Current



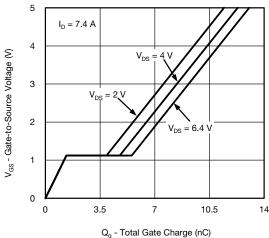
Transfer Characteristics



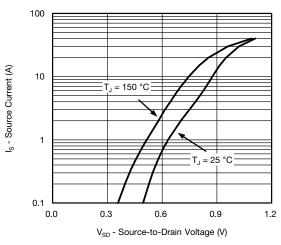
Capacitance

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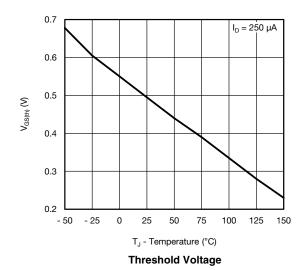
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

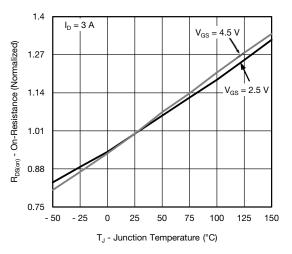


Gate Charge

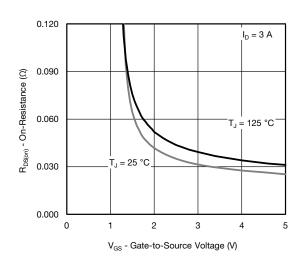


Soure-Drain Diode Forward Voltage

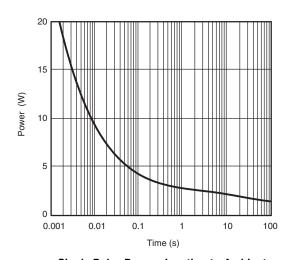




On-Resistance vs. Junction Temperature



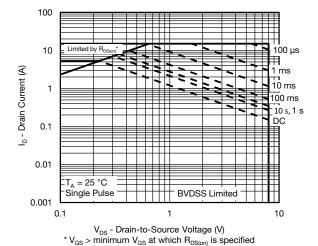
On-Resistance vs. Gate-to-Source Voltage



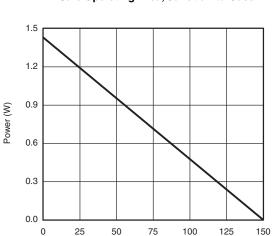
Single Pulse Power, Junction-to-Ambient



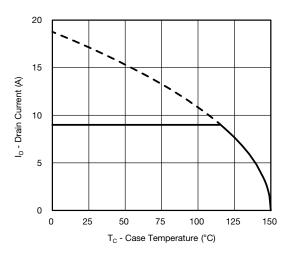
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



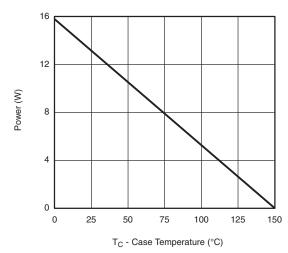
Safe Operating Area, Junction-to-Case



T_A - Ambient Temperature (°C) **Power Junction-to-Ambient**



Current Derating**

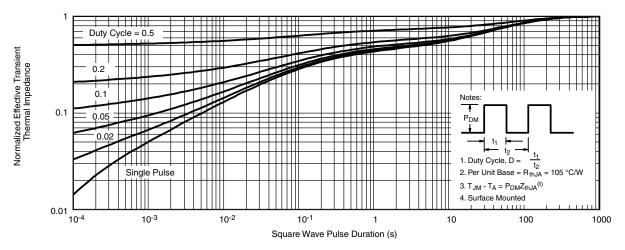


Power Junction-to-Case

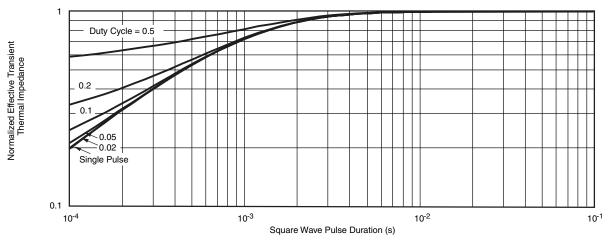
^{**} The power dissipation P_D is based on $T_{J(max.)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



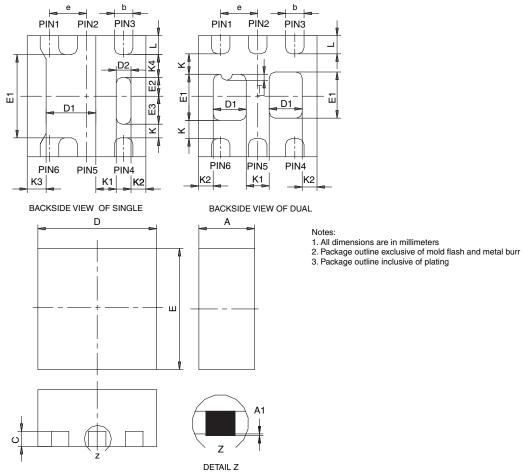
Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63899.





PowerPAK® SC75-6L



	SINGLE PAD						DUAL PAD					
DIM	М	ILLIMETER	RS		INCHES		M	MILLIMETERS			INCHES	
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032
A 1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002
b	0.18	0.25	0.33	0.007	0.010	0.013	0.18	0.25	0.33	0.007	0.010	0.013
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010
D	1.53	1.60	1.70	0.060	0.063	0.067	1.53	1.60	1.70	0.060	0.063	0.067
D1	0.57	0.67	0.77	0.022	0.026	0.030	0.34	0.44	0.54	0.013	0.017	0.021
D2	0.10	0.20	0.30	0.004	0.008	0.012						
E	1.53	1.60	1.70	0.060	0.063	0.067	1.53	1.60	1.70	0.060	0.063	0.067
E1	1.00	1.10	1.20	0.039	0.043	0.047	0.51	0.61	0.71	0.020	0.024	0.028
E2	0.20	0.25	0.30	0.008	0.010	0.012						
E3	0.32	0.37	0.42	0.013	0.015	0.017						
е		0.50 BSC			0.020 BSC	;		0.50 BSC		0.020 BSC		
K		0.180 TYP 0.007 TYP		0.245 TYP			0.010 TYP					
K1	0.275 TYP		0.011 TYP		0.320 TYP		0.013 TYP					
K2	0.200 TYP		0.008 TYP		0.200 BSC		0.008 TYP					
К3	0.255 TYP			0.010 TYP								
K4	0.300 TYP		0.012 TYP									
L	0.15	0.25	0.35	0.006	0.010	0.014	0.15	0.25	0.35	0.006	0.010	0.014
Т							0.03	0.08	0.13	0.001	0.003	0.005

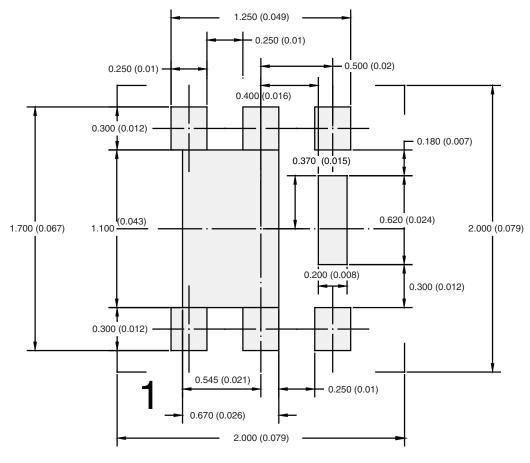
ECN: C-07431 - Rev. C, 06-Aug-07

DWG: 5935

Document Number: 73000 06-Aug-07



RECOMMENDED PAD LAYOUT FOR PowerPAK® SC75-6L Single



Dimensions in mm/(Inches)

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ATTLICATION NOT



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